

	1	2	3	4	5	6	7	
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A								A
B						<p>NOTES:</p> <p>Mechanical:</p> <p>1. Housing material : High Temp. UL94V-0 , Color: Black</p> <p>2. Contact material: Phosphor Bronze t=0.35mm</p> <p>⑥⑤ 3. Contact plating: 6u" Gold on contact area 100~200u" Tin on solder area all over 30~50u" Nickel</p>		B
C						<p>⑤ 4. Shell material: Copper Alloy</p> <p>5. Shell plating: Nickel plated</p> <p>6. PCB Retention Pre-solder: 1 LB min.</p> <p>7. PCB Retention Post-solder: 10 LBS min.</p>		C
D								D
E	<p>PC Board Layout Component Side Shown</p>					<p>Electrical:</p> <p>1. Voltage Rating: 125VAC.</p> <p>2. Current Rating: 1.5AMP.</p> <p>3. Contact Resistance: 35mΩ max.</p> <p>4. Insulation Resistance: 1000MΩ min. @ 500 VDC</p> <p>5. Dielectric Strength: 1000 VAC 60Hz, 1 min.</p> <p>6. Operation: 750 cycles min.</p> <p>Environmental:</p> <p>1. Storage: -40°C To +85°C</p> <p>2. Operation: -40°C~+85°C</p> <p>3. Wave Soldering Temperature: 255~265°C(5-10S) CAT performance:CAT3</p> <p>Packing: Tray</p>		E
F								F

G	<p>RoHS compliant Unit:mm</p> <p>File No.: E345352</p>	Scale	Free	⑦ Update	05.03.2020	Winnie	Date	Name	Customer-No.
		TOLERANCE		⑥ Update the contact plating	25.05.2015	Amy	Drawn	29.05.2006	N.Schulz
H		X.X	±0.20	⑤ Update	27.05.2013	Amy	Approved	05.03.2020	ASSMANN WSW-No.
		X.XX	±0.15	④ Change insulation material	10.06.2010	Dean			A-20142-LP/FS
H		X.XXX	±0.10	③ Update	02.07.2009	Dean			Drawing-No.
		DIM	TOL	② Change plant	27.02.2008	Hellwig			ASS 0473 CO
Angle	±5°	Id.	Modification	Date	Name	Replace			SHEET

	1	2	3	4	5	6	7	
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